

SG1200(R,U,W,EX)23

GATE TURN-OFF THYRISTOR

CHOPPER, INVERTER APPLICATION

- Repetitive Peak Off-State Voltage : $V_{DRM}=1300, 1600, 1800, 2500V$
- R.M.S On-State Current : $I_{T(RMS)}=400A$
- Peak Turn-Off Current : $I_{TGQM}=1200A$
- Critical Rate of Rise of On-State Current : $di/dt=250A/\mu s$
- Critical Rate of Rise of Off-State Voltage : $dv/dt=900V/\mu s$

MAXIMUM RATINGS

CHARACTERISTIC		SYMBOL	RATING	UNIT
Repetitive Peak Off-State Voltage	SG1200R23	V_{DRM}	1300	V
	SG1200U23		1600	
	SG1200W23		1800	
	SG1200EX23		2500	
Repetitive Peak Reverse Voltage		V_{RRM}	15	V
Peak Turn-Off Current (Note 1)		I_{TGQM}	1200	A
R.M.S On-State Current (Note 2)		$I_{T(RMS)}$	400	A
Peak One Cycle Surge On-State Current (Non-Repetitive)		I_{TSM}	6500(50Hz)	A
			7100(60Hz)	
Critical Rate of Rise of On-State Current (Note 3)		di/dt	250	A/ μs
Peak Forward Gate Current (Note 4)		I_{FGM}	40	A
Average Forward Gate Power Dissipation		$P_{G(AV)}$	8	W
R.M.S Reverse Gate Current		$I_{RG(RMS)}$	50	A
Peak Reverse Gate Power Dissipation (Note 5)		P_{RGM}	8	kW
Peak Reverse Gate Voltage		V_{RGM}	15	V
Storage Temperature Range		T_{stg}	-40~125	$^{\circ}C$
Operating Junction Temperature Range		T_j	-40~125	$^{\circ}C$
Mounting Force		-	1200 \pm 120	kg

Note 1 : $V_D=1/2$ Rated, $V_{DJ}=2/3$ Rated, $C_S=2\mu F$, $R_S=20\Omega$, $di_{RG}/dt=30A/\mu s$
 $I_{RG}\neq 260A$, $T_j=125^{\circ}C$, ($V_{DSP}\leq 450V$)

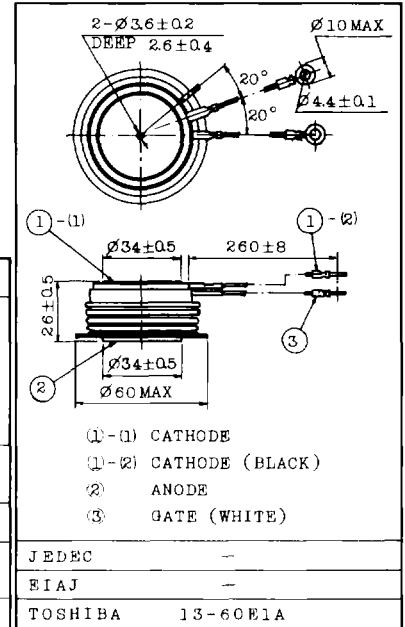
Note 2 : Half sine waveform, $T_f=70^{\circ}C$

Note 3 : $V_D=1/2$ Rated, $I_{TM}=1200A$, $I_G=18A$, $t_r=1\mu s$, $f=50Hz$, $T_j=125^{\circ}C$

Note 4 : Pulse width : Max. 20 μs , Duty : Max. 20%

Note 5 : Pulse width : Max. 20 μs , Duty : Max. 2%

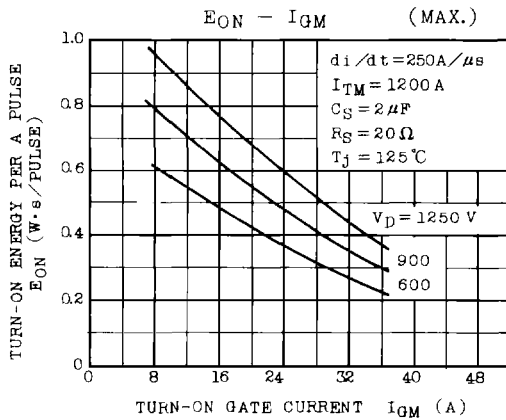
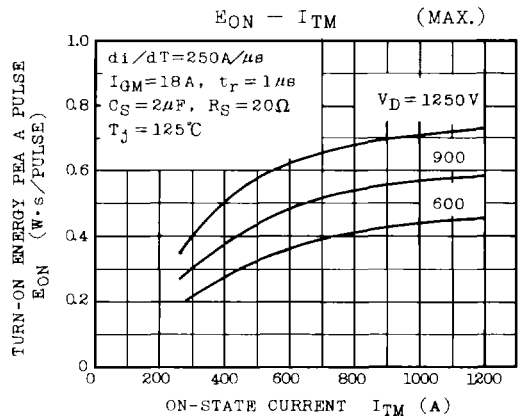
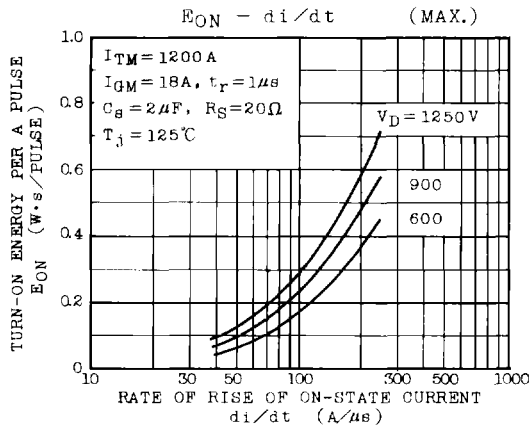
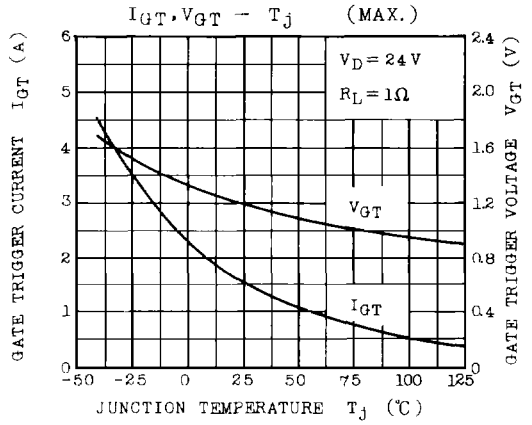
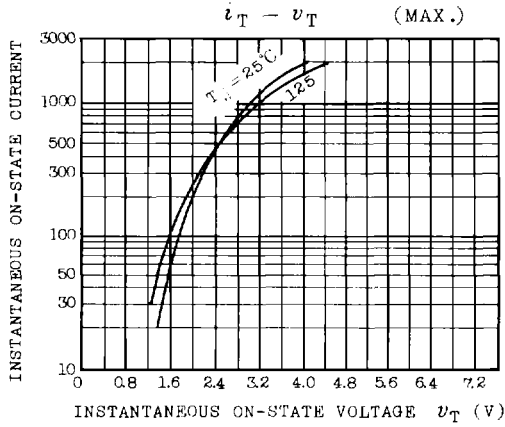
Unit in mm

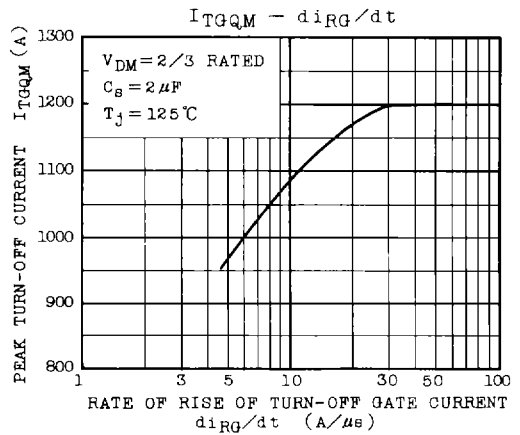
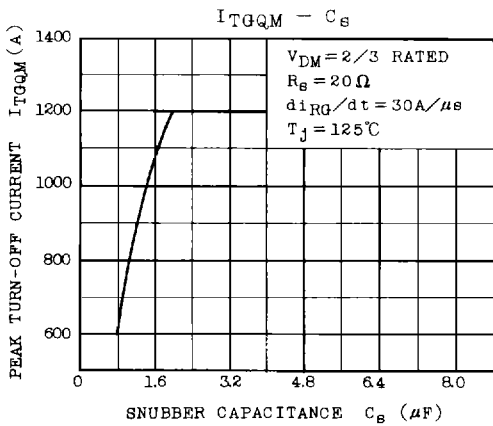
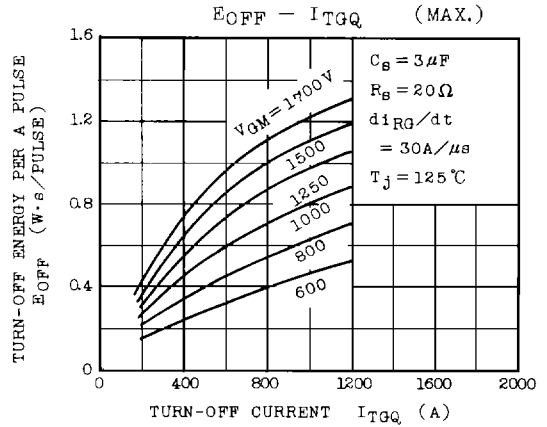
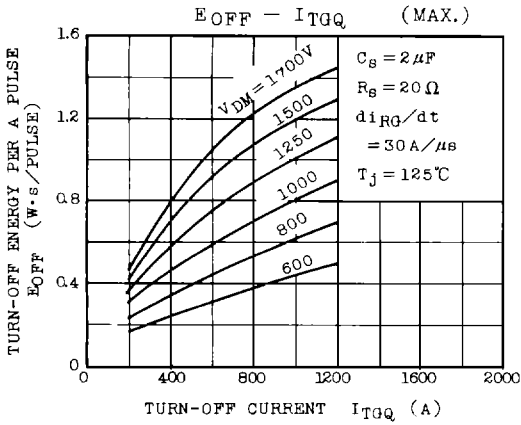
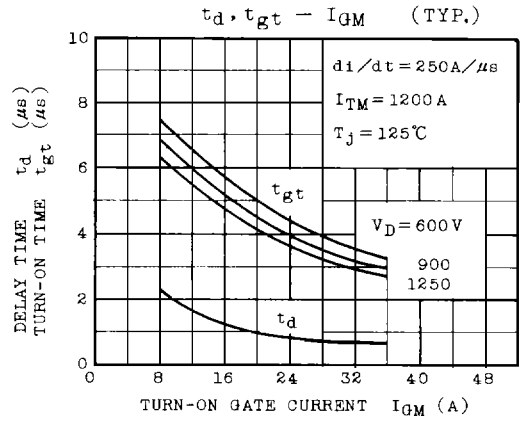
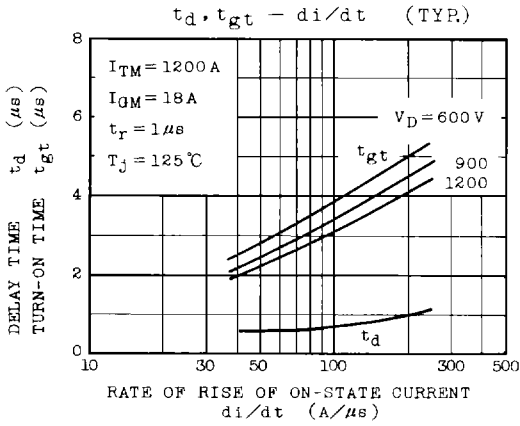


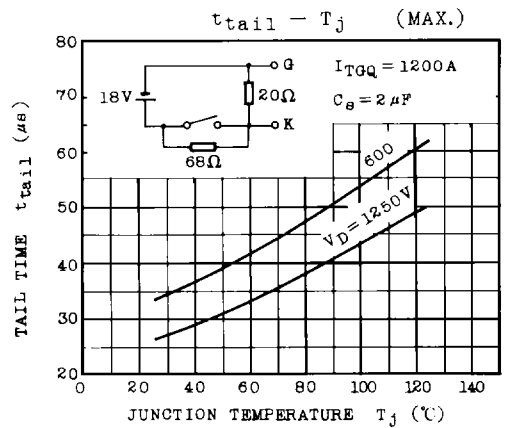
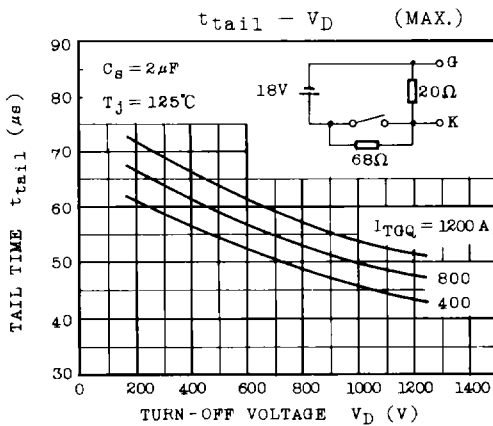
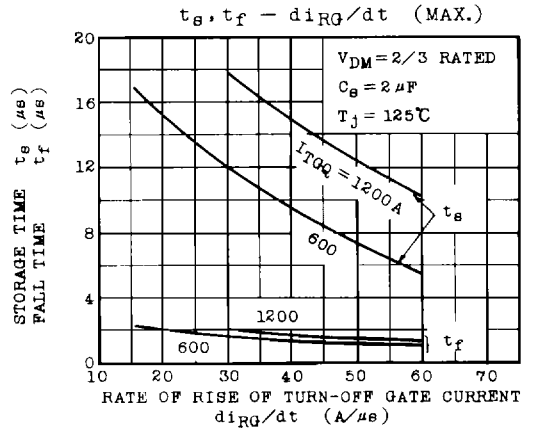
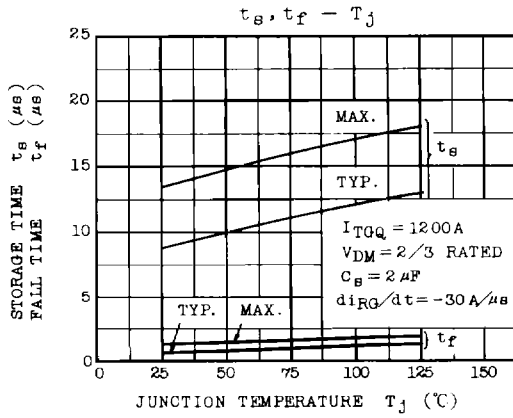
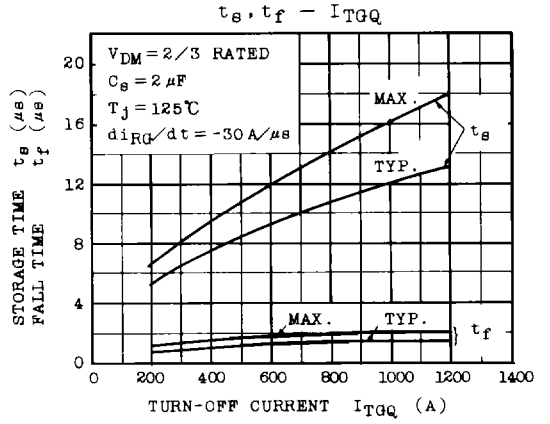
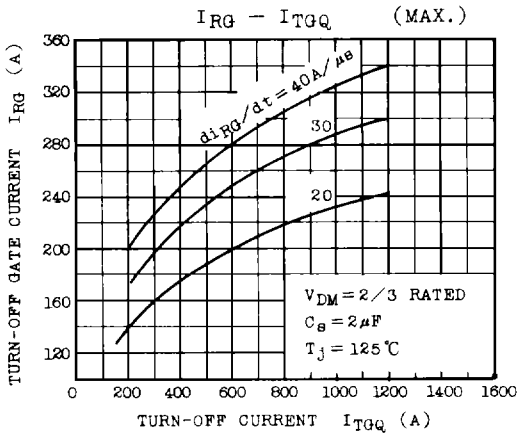
Weight : 290g

ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Repetitive Peak Off-State Current	I _{DRM}	V _{DRM} =Rated, R _{GK} =20Ω T _j =125°C	-	-	20	mA	
Repetitive Peak Reverse Current	I _{RRM}	V _{RRM} =Rated, T _j =125°C	-	-	100	mA	
Repetitive Peak Reverse Gate Current	I _{RGM}	V _{RGM} =Rated, T _j =125°C	-	-	100	mA	
Peak On-State Voltage	V _{TM}	I _{TM} =1000A, T _c =25°C	-	-	3.0	V	
Gate Trigger Voltage	V _{GT}	V _D =24V	T _c =-40°C	-	-	1.7	V
			T _c =25°C	-	0.85	1.2	
Gate Trigger Current	I _{GT}	R _L =1Ω	T _c =-40°C	-	-	4000	mA
			T _c =25°C	-	700	1500	
Gate Non-Trigger Voltage	V _{GD}	V _D =1/2 Rated, T _c =125°C	0.3	-	-	V	
Gate Non-Trigger Current	I _{GD}		5	-	-	mA	
Delay Time	t _d	V _D =1/2 Rated di/dt=250A/μs	-	-	2	μs	
Turn-On Time	t _{gt}	I _{TM} =1200A, I _G =18A t _r =1μs, T _c =25°C	-	-	8	μs	
Critical Rate of Rise of Off-State Voltage	dv/dt	V _{DRM} =2/3 Rated T _j =125°C, V _{GK} =-4V Exponential Rise	900	-	-	V/μs	
Holding Current	I _H	T _c =25°C, R _L =1Ω	-	20	-	A	
Storage Time	t _s	I _T =1200A, V _D =1/2 Rated	-	15	18	μs	
Gate Turn-Off Time	t _{gq}	V _{DM} =2/3 Rated, C _S =2μs	-	-	20	μs	
Tail Time	t _{tail}	di _{RG} /dt=-30A/μs	-	-	60	μs	
Gate Turn-Off Current	I _{RG}	T _c =120°C	-	260	300	A	
Thermal Resistance	R _{th(j-f)}	Junction to Fin	-	-	0.05	°C/W	







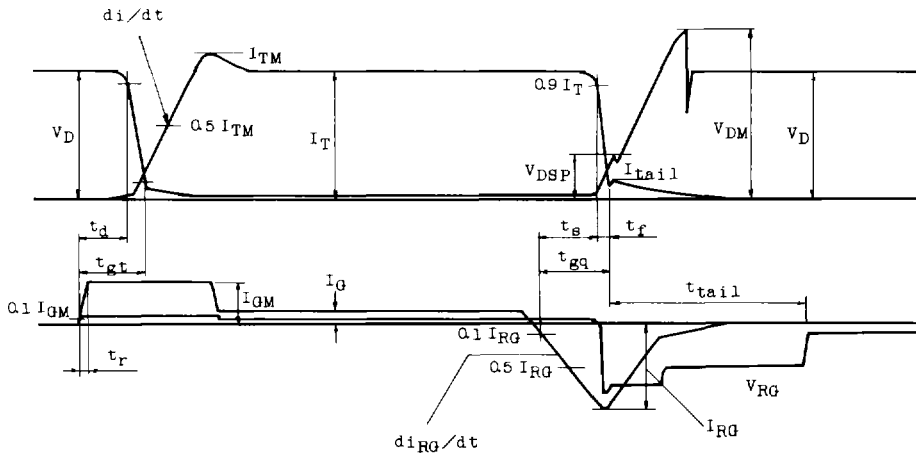
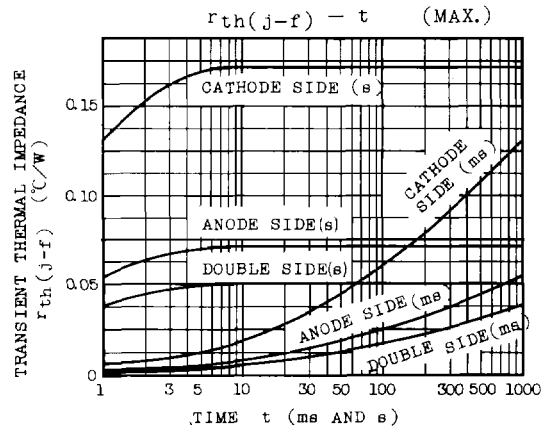
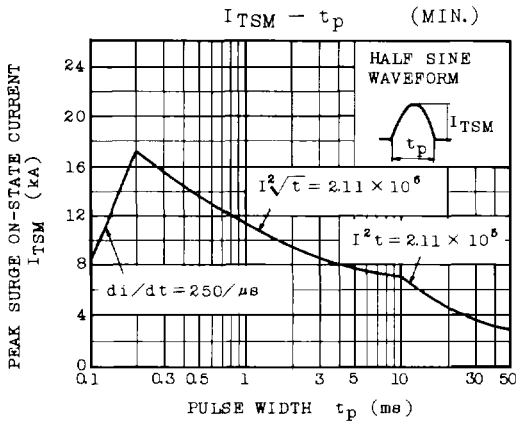


Fig. 1 TURN-ON AND TURN-OFF CHARACTERISTIC OF GTO